S101S05V/S101S06V S201S05V/S201S06V

SIP Type SSR with **Mounting Capability for External Heat Sink**

■ Features

1. High radiation resin mold package.

2. RMS ON-state current

 I_T : MAX. 3Arms at $T_C \le 100^{\circ}$ C

(With heat sink)

3. Isolation voltage between input and output

 $(V_{iso}: 3\ 000\ V_{rms})$

4. Built-in zero-cross circuit (S101S06V/S201S06V)

5. Recognized by UL, file No. E94758 Approved by CSA, No. LR63705

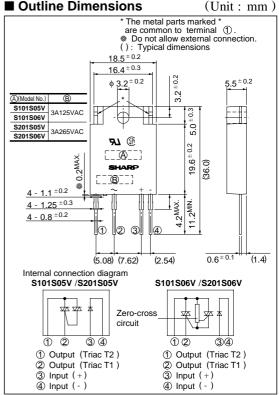
■ Applications

- 1. OA equipment such as copiers
- 2. FA equipment

■ Model Line-ups

	For 100V lines	For 200V lines
No built-in zero-cross circuit	S101S05V	S201S05V
Built-in zero-cross circuit	S101S06V	S201S06V

■ Outline Dimensions



 $(Ta = 25^{\circ}C)$

■ Absolute Maximum Ratings

				` -	,
Parameter		Symbol	Rating S101S05V/S101S06V S201S05V/S201S06V		Unit
Input	Forward current	I_F	50		mA
	Reverse voltage	V _R	6		V
Output	RMS ON-state current	I_T	*43		A rms
	*1Peak one cycle surge current	I surge	30		A
	Repetitive peak OFF-state voltage	V DRM	400	600	V
	Non-repetitive peak OFF-state voltage	V _{DSM}	400	600	V
	Critical rate of rise of ON-state current	dI _T /dt	40		A/μs
	Operating freguency	f	45 to 65		Hz
*2 Isolation voltage		V iso	3 000		V _{rms}
Operating temperature		T opr	- 25 to + 100		°C
Storage temperature		T stg	- 30 to + 125		°C
*3 Soldering temperature		T sol	260		°C

^{*1 60}Hz sine wave, start at Tj= 25°C

^{*2 60}Hz AC for 1 minute, 40 to 60% RH. Apply voltages between input and output, by the dielectric withstand voltage tester with zero-cross circuit. (Input and output shall be shorted respectively)

⁽Note) When the isolation voltage is necessary at using external heat sink, please use the insulation sheet.

^{*3} For 10 seconds

^{*4} Tc<=100°C

■ Electrical Characteristics

 $(Ta = 25^{\circ}C)$

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit		
Input	Foward voltage		VF	$I_F = 20mA$	-	1.2	1.4	V	
	Reverse current		I_R	$V_R = 3V$	-	-	10 -4	A	
Output	Repetitive peak OFF-state current		I_{DRM}	$V_D = V_{DRM}$	-	-	10 -4	A	
	RMS ON-state current			V _T	Resistance load, I $_F = 20mA$ I $_T = 1.5A_{rms}$	-	-	1.5	V rms
	Holding current		I _H	-	-	-	50	mA	
	Critical rate of rise of OFF-state voltage			dV/dt	$V_D = 2/3V_{DRM}$	30	-	-	V/μ s
	Critical rate of rise of commutating OFF-state voltage		(dV/dt) _C	$Tj = 125$ °C, $V_D = 400V$ $dI_t/d_t = -1.5A/ms$	4	-	-	V/μ s	
Transfer	Minimum trigger current	S101S	05V/ S201S05V	I _{FT}	$V_D = 12V, R_L = 30\Omega$	-	-	15	mA
		S101S	06V/S201S06V		$V_D = 6V$, $R_L = 30\Omega$	-	-	15	
	Isolation resistance		R _{ISO}	DC500V, 40 to 60 % RH	1010	-	-	Ω	
	7 1		S101S06V	3.7	T 15 A	-	-	35	v
charac-	Zero-cross voltage		S201S06V	Vox	$I_F = 15mA$	-	-	35	V
teristics	Turn-on time	S101S	05V / S201S05V		AC50Hz	-	-	1	ms
		S101S	06V / S201S06V	t _{on}		-	-	10	
	Turn-off time	05V / S201S05V		AC50Hz	-	-	10	***	
		S101S	06V/S201S06V	t off	AC50HZ	-	-	10	ms
Thermal resistance (Between junction and case)		R th(j-c)	-	-	6	-	°C/W		
	Thermal resistance (Between junction and ambience)			R _{th(j-a)}	-	-	45	-	°C/W

Fig. 1 RMS ON-state Current vs.
Ambient Temperature

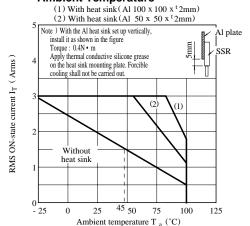


Fig. 2 RMS ON-state Current vs.

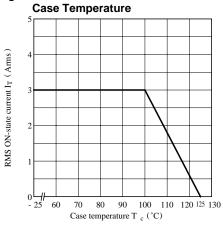


Fig. 3 Forward Current vs.

Ambient Temperature

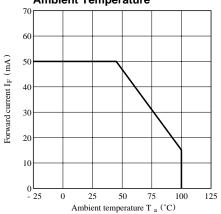


Fig. 5 Surge Current vs. Power-on Cycle

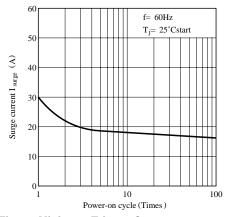


Fig.7-a Minimum Trigger Current vs.
Ambient Temperature (Typical Value)
(S101S05V/S201S05V)

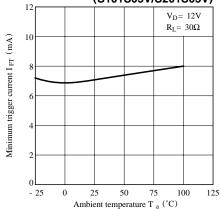


Fig. 4 Forward Current vs. Forward Voltage

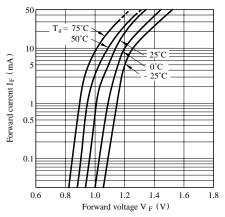


Fig. 6 Maximum ON-state Power Dissipation vs. RMS ON-state Current

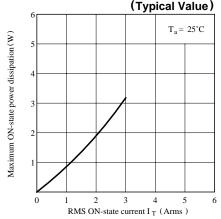


Fig.7-b Minimum Trigger Current vs.
Ambient Temperature (Typical Value)

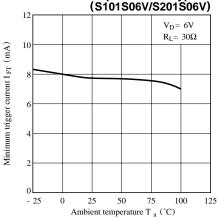
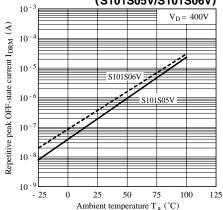
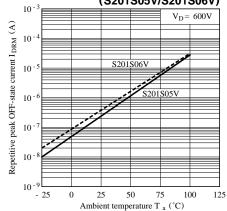


Fig.8-a Repetitive Peak OFF-state Current vs.
Ambient Temperature (Typical Value)
(S101S05V/S101S06V)



• Please refer to the chapter "Precautions for Use"

Fig.8-b Repetitive Peak OFF-state Current vs.
Ambient Temperature (Typical Value)
(S201S05V/S201S06V)



NOTICE

- •The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- •Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
 - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
 - Personal computers
 - Office automation equipment
 - Telecommunication equipment [terminal]
 - Test and measurement equipment
 - Industrial control
 - Audio visual equipment
 - Consumer electronics
 - (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
 - Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
 - Traffic signals
 - Gas leakage sensor breakers
 - Alarm equipment
 - Various safety devices, etc.
 - (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
 - Space applications
 - Telecommunication equipment [trunk lines]
 - Nuclear power control equipment
 - Medical and other life support equipment (e.g., scuba).
- •Contact a SHARP representative in advance when intending to use SHARP devices for any "specific" applications other than those recommended by SHARP or when it is unclear which category mentioned above controls the intended use.
- •If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Control Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- •This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- Contact and consult with a SHARP representative if there are any questions about the contents of this
 publication.